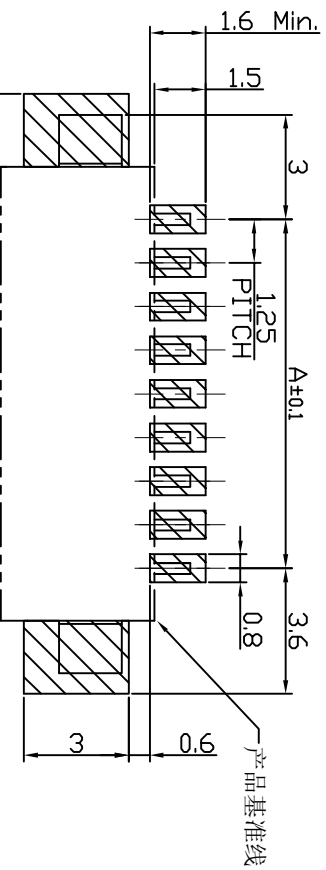


Pin位	A	B	C
2	1.25	4.25	7.3
3	2.5	5.5	8.55
4	3.75	6.75	9.8
5	5	8	11.05
6	6.25	9.25	12.3
7	7.5	10.5	13.55
8	8.75	11.75	14.8
9	10	13	16.05
10	11.25	14.25	17.3
11	12.5	15.5	18.55
12	13.75	16.75	19.8
13	15	18	21.05
14	16.25	19.25	22.3
15	17.5	20.5	23.55
16	18.75	21.75	24.8



PCB Layout

SPECIFICATION
 1. Material:
 Housing: HIGH-TEMP Plastic, UL94V-0, color: Natural.
 Contacts: Copper alloy.
 Solder tab: Copper alloy.
 2. Electrical Characteristics:
 Current rating: 1A(max).
 Voltage rating: 200V(max).
 Operating Temperature: -25°C~+85°C.
 Insulation resistance: 1000M ohms min. at 1000V DC
 Dielectric withstanding voltage: 1000V AC/minute.
 Contact resistance: 30m ohms max.

UNITS: mm	CSCONN		CSCONN PRECISE ELECTRONICS CO.,LTD	
GENERAL TOLERANCE	PART NO. (INTENDED USE)	TITLE:	DWG NO. WAFER	
X. ° ±5°	CWF-125XXL-T	WAFER 1.25MM XP 单排立贴		
X.1 ±2°	APPD:		SCALE	SHEET
XX. ±1°	CHKD: Skilla		1:1	1 OF 1
	DR: Kitty			REV
				A